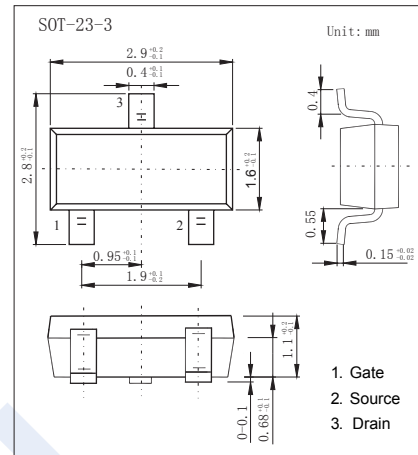
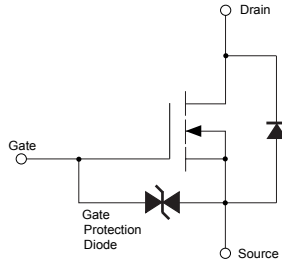


N-Channel MOSFET

2SK3018

■ Features

- $V_{DS} = 30V$
- $I_D = 0.1 A$
- $R_{DS(ON)} < 8 \Omega$ ($V_{GS} = 4V$)
- $R_{DS(ON)} < 13 \Omega$ ($V_{GS} = 2.5V$)



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	100	mA
Pulsed Drain Current (Note.1)	I_{DM}	400	
Power Dissipation	P_D	200	mW
Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 to 150	

Note.1: $PW \leq 10\mu s$, Duty Cycle $\leq 1\%$

■ Electrical Characteristics $T_a = 25^\circ C$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	$I_D = 250 \mu A$, $V_{GS} = 0V$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30V$, $V_{GS} = 0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{DS} = 0V$, $V_{GS} = \pm 20V$			± 1	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = 3V$, $I_D = 0.1mA$	0.8		1.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 4V$, $I_D = 10mA$			8	Ω
		$V_{GS} = 2.5V$, $I_D = 1mA$			13	
Forward Transconductance	g_{FS}	$V_{DS} = 3V$, $I_D = 10mA$	20			mS
Input Capacitance	C_{iss}	$V_{GS} = 0V$, $V_{DS} = 5V$, $f = 1MHz$		13		pF
Output Capacitance	C_{oss}			9		
Reverse Transfer Capacitance	C_{rss}			4		
Turn-On DelayTime	$t_{d(on)}$		$V_{GS} = 5V$, $V_{DS} = 5V$, $I_D = 10mA$, $R_L = 500 \Omega$, $R_G = 10 \Omega$		15	
Turn-On Rise Time	t_r			35		
Turn-Off DelayTime	$t_{d(off)}$			80		
Turn-Off Fall Time	t_f			80		

■ Marking

Marking	KN
---------	----

N-Channel MOSFET 2SK3018

Typical Characteristics

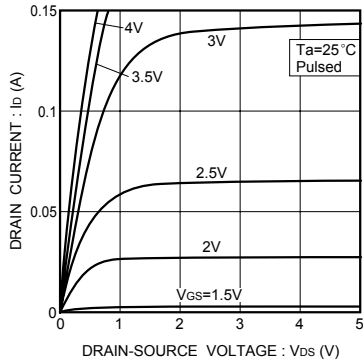


Fig.1 Typical output characteristics

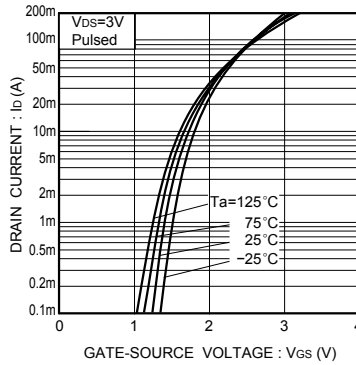


Fig.2 Typical transfer characteristics

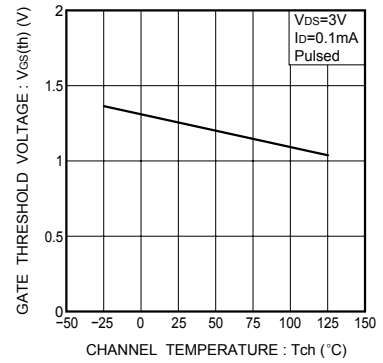


Fig.3 Gate threshold voltage vs. channel temperature

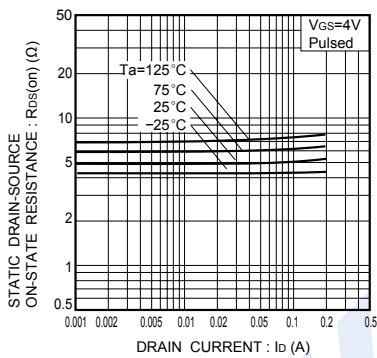


Fig.4 Static drain-source on-state resistance vs. drain current (I)

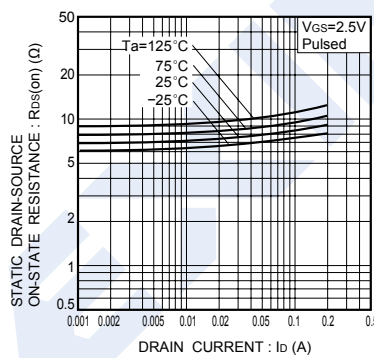


Fig.5 Static drain-source on-state resistance vs. drain current (II)

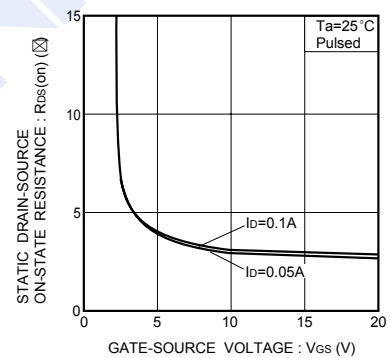


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

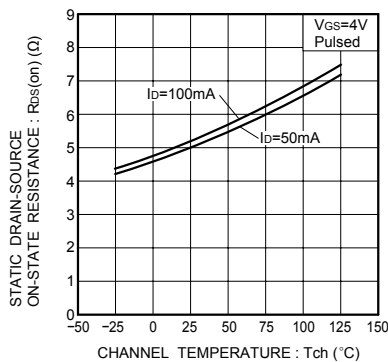


Fig.7 Static drain-source on-state resistance vs. channel temperature

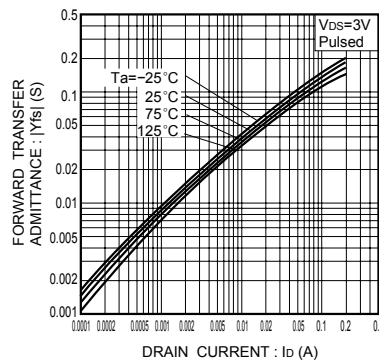


Fig.8 Forward transfer admittance vs. drain current

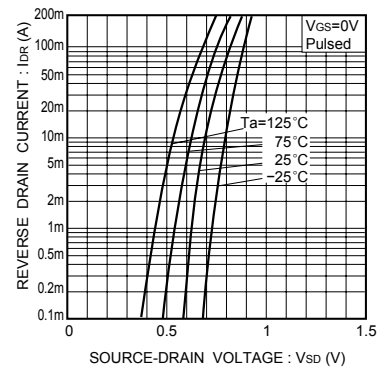


Fig.9 Reverse drain current vs. source-drain voltage (I)

N-Channel MOSFET 2SK3018

■ Typical Characteristics

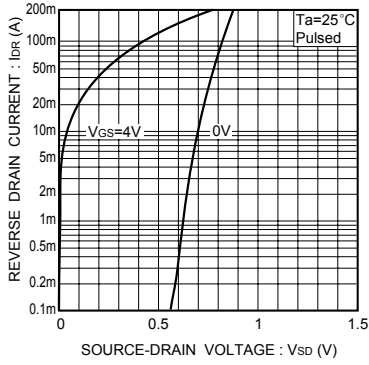


Fig.10 Reverse drain current vs. source-drain voltage (II)

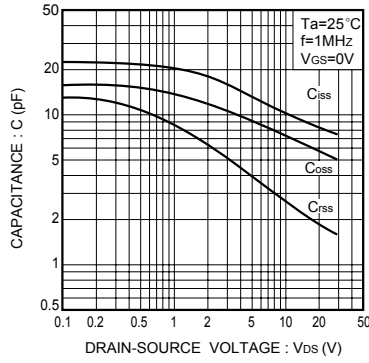


Fig.11 Typical capacitance vs. drain-source voltage

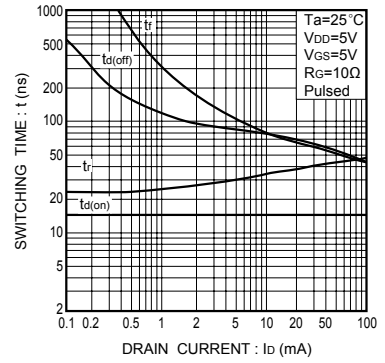


Fig.12 Switching characteristics (See Figures 13 and 14 for the measurement circuit and resultant waveforms)

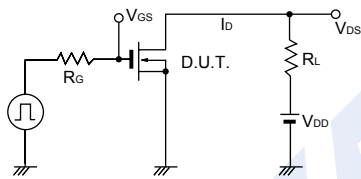


Fig.13 Switching time measurement circuit

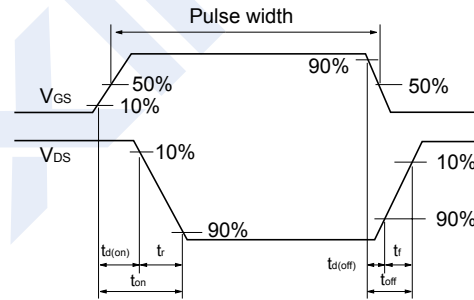


Fig.14 Switching time waveforms